

[54] MEMORANDUM INPUT/OUTPUT DEVICE

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[73] Assignee: Sharp Corporation, Osaka, Japan

[*] Notice: The portion of the term of this patent subsequent to Jul. 31, 2004 has been disclaimed.

[**] Term: 14 Years

[21] Appl. No.: 285,949

[22] Filed: Dec. 15, 1988

[30] Foreign Application Priority Data

Jul. 11, 1988 [JP] Japan 63-27735

[52] U.S. Cl. D14/100; D18/7

[58] Field of Search D18/1, 6, 7; D14/100, D14/106, 107, 113, 115; 235/145 A, 145 R; 364/706-710

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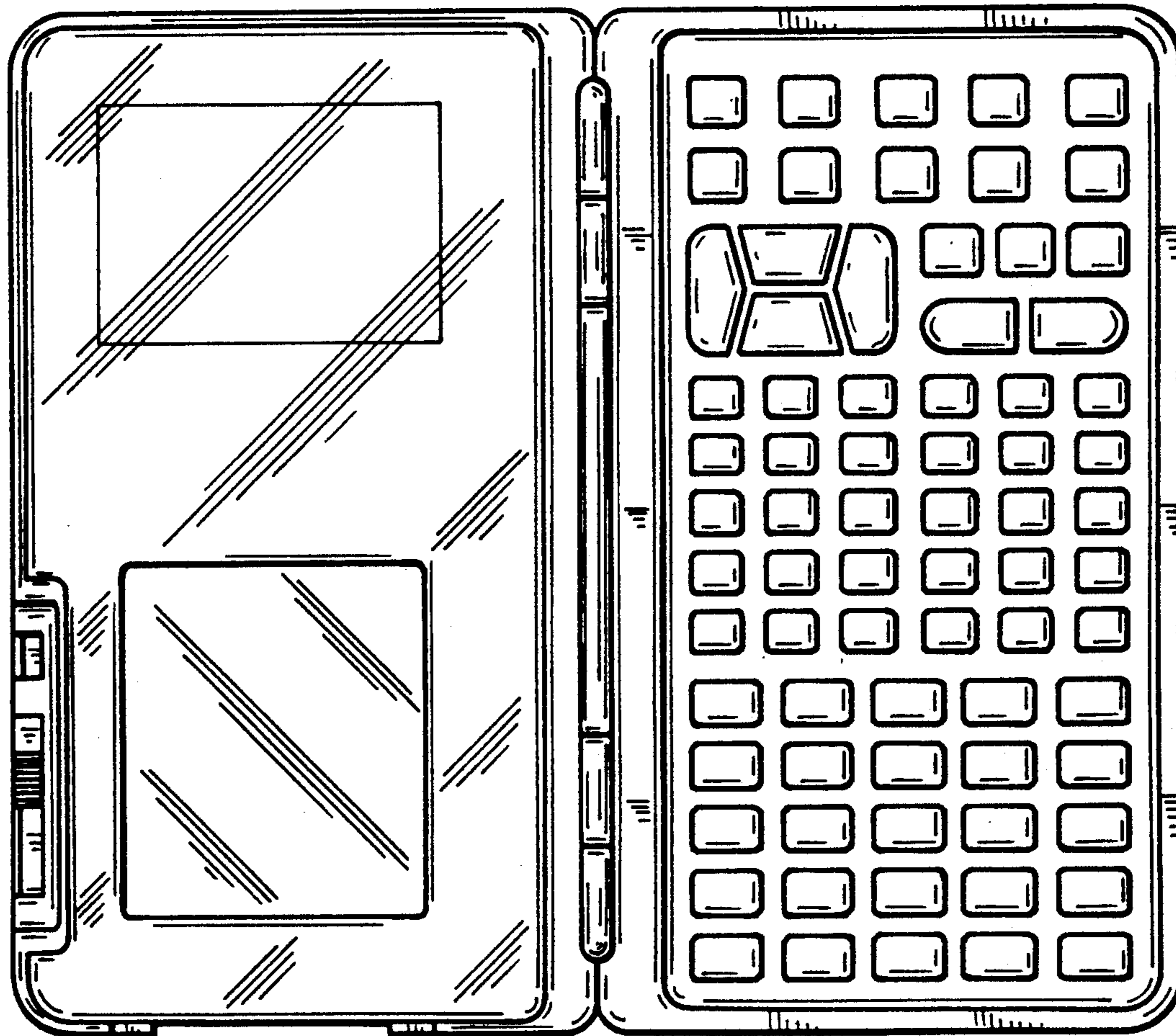
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Attorney, Agent, or Firm—Flehr, Hohbach, Test, Albritton & Herbert

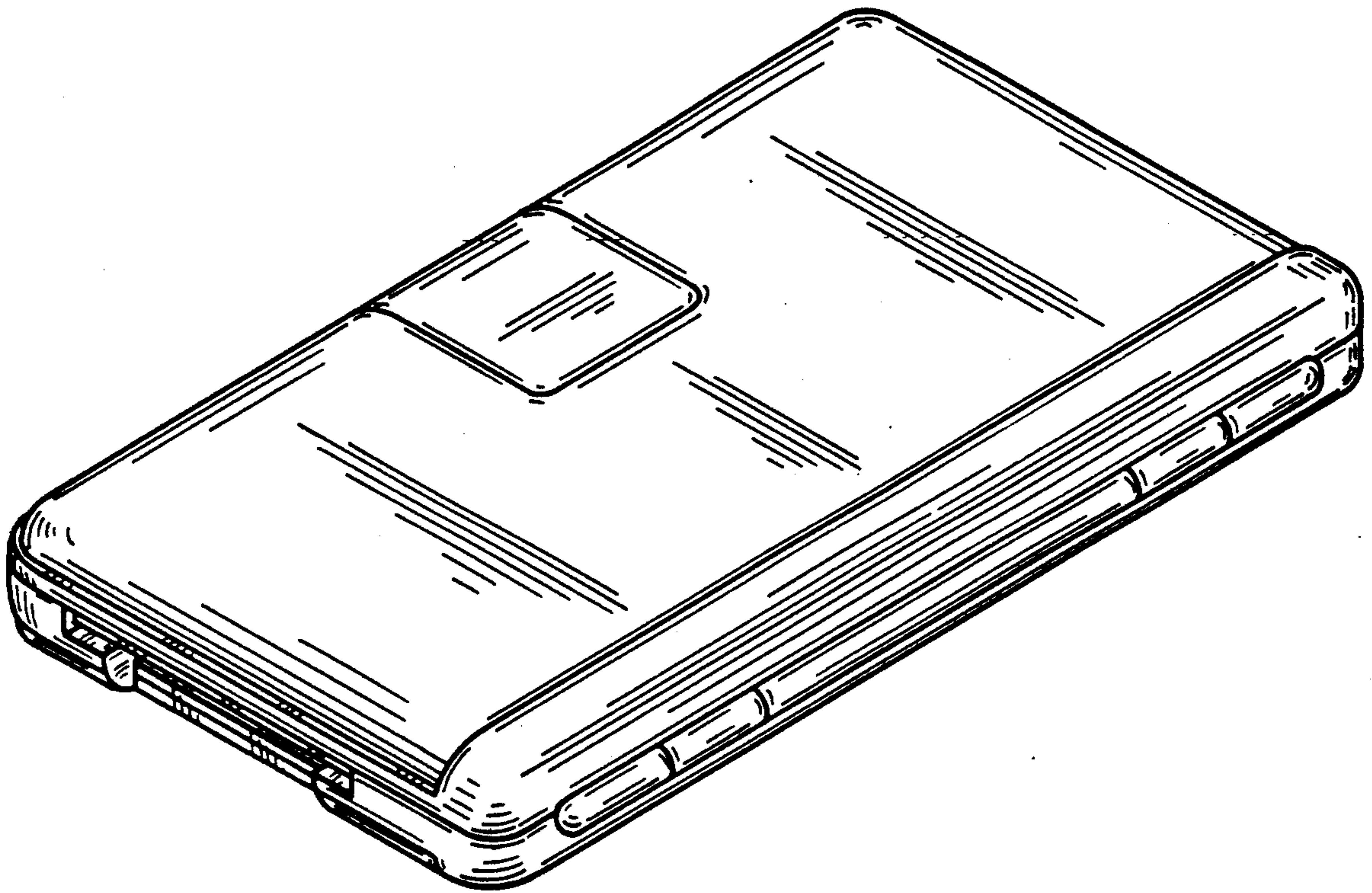
[57] CLAIM

The ornamental design for a memorandum input/output device, shown and described.

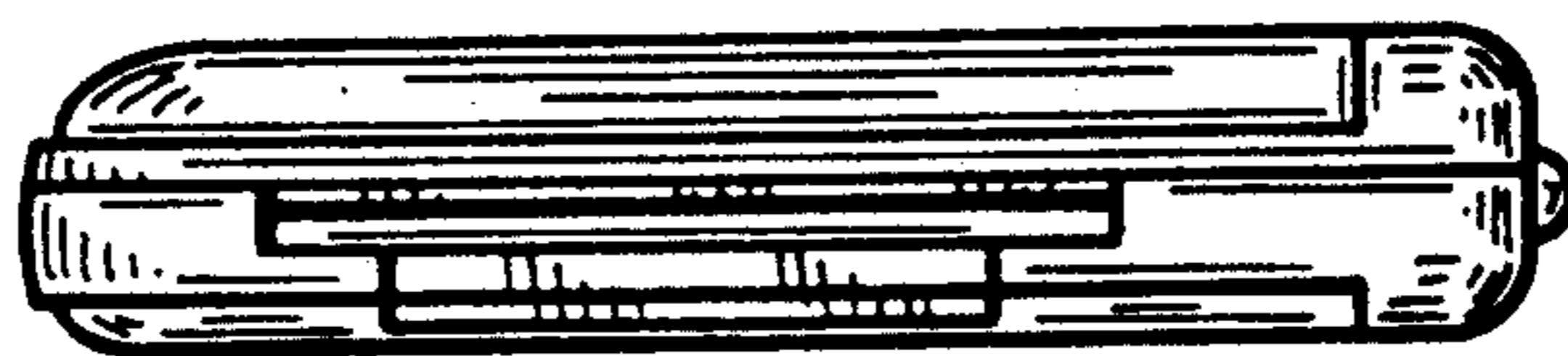
DESCRIPTION

FIG. 1 is a perspective view of a memorandum input/output device showing our new design, with the cover in the closed position;
 FIG. 2 is a top plan view thereof;
 FIG. 3 is a bottom plan view thereof;
 FIG. 4 is a front elevational view thereof;
 FIG. 5 is a rear elevational view thereof;
 FIG. 6 is a right side elevational view thereof;
 FIG. 7 is a left side elevational view thereof;
 FIG. 8 is a top plan view thereof with the cover open;
 FIG. 9 is a front elevational view thereof with the cover open; and
 FIG. 10 is a right side elevational view thereof with the cover open.

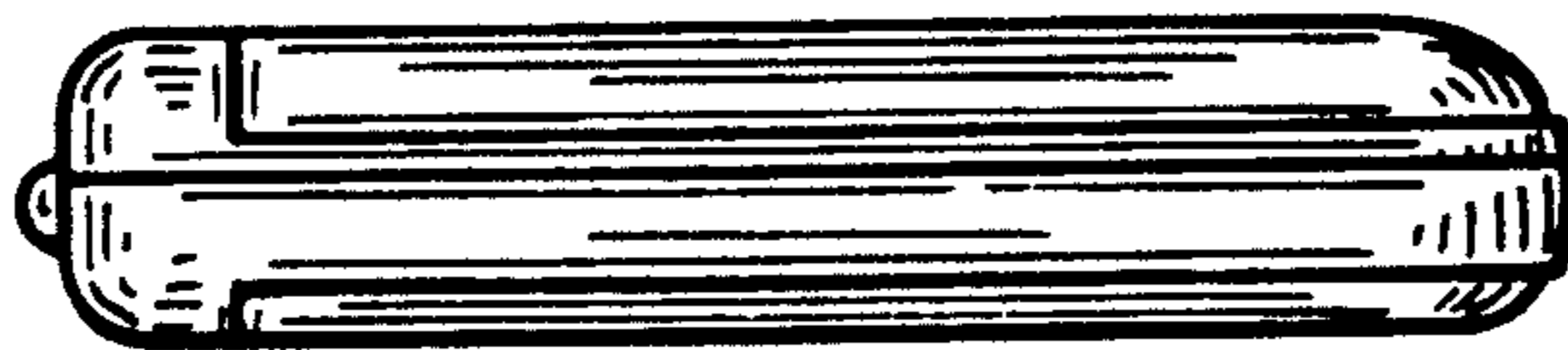




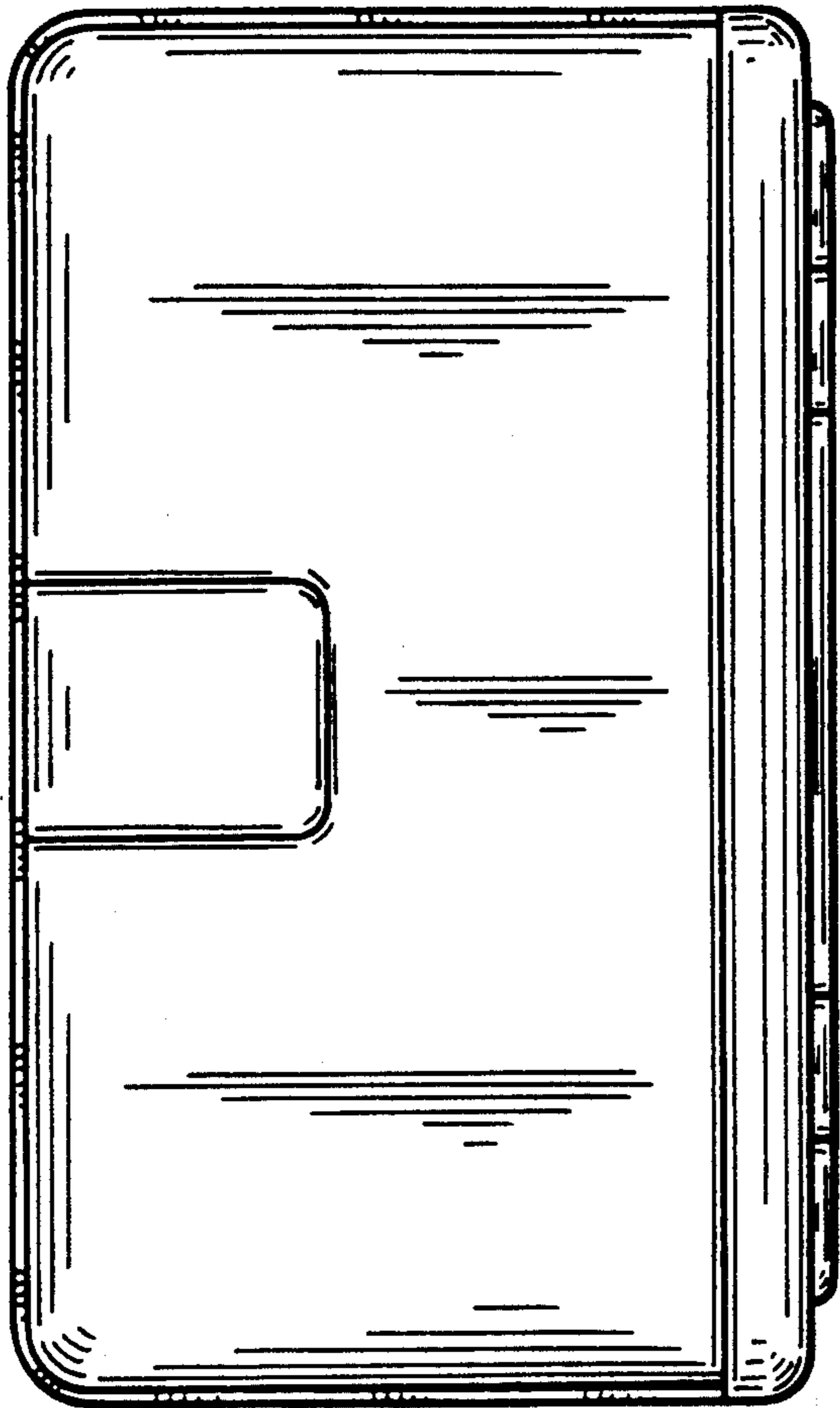
FIG_1



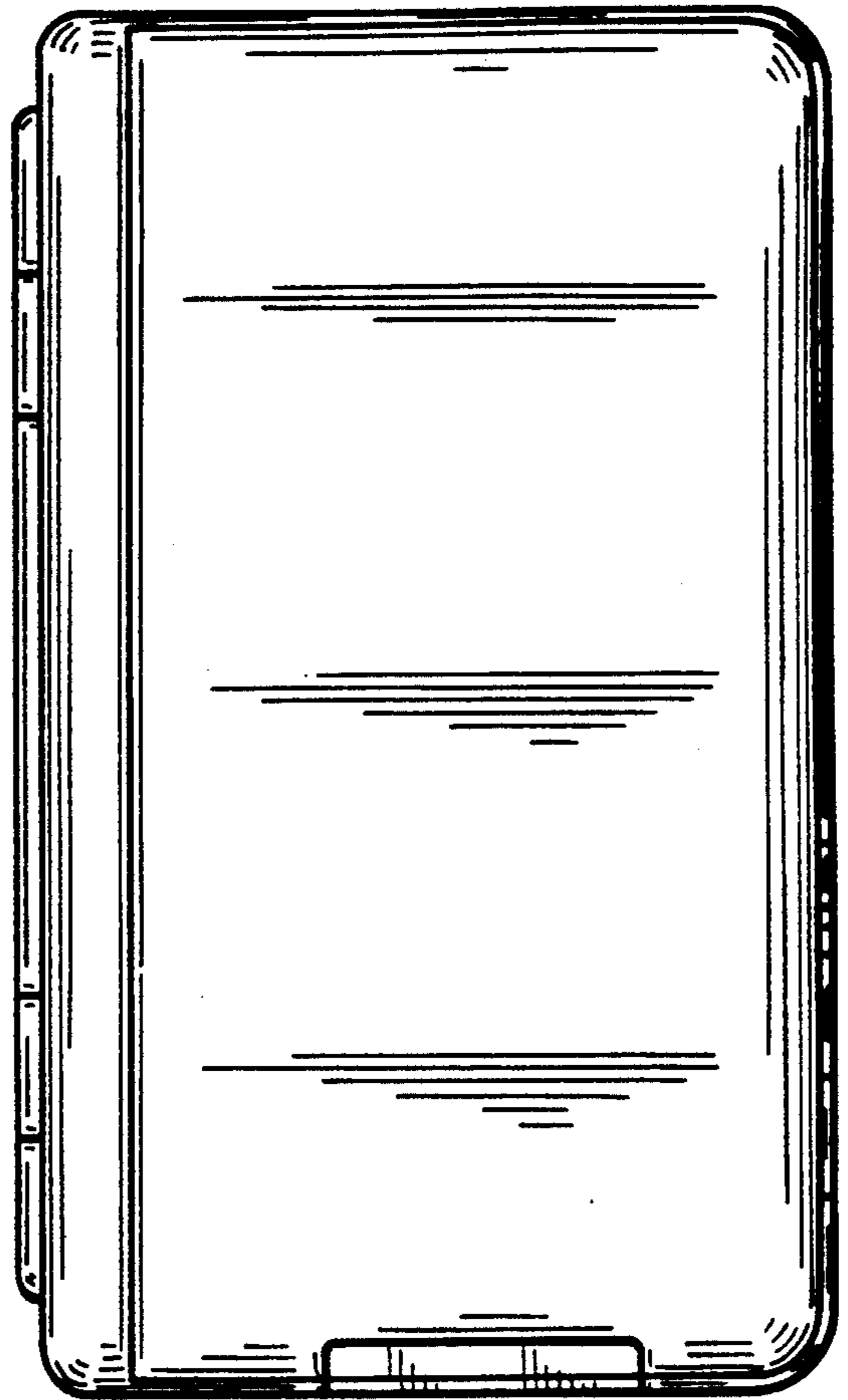
FIG_4



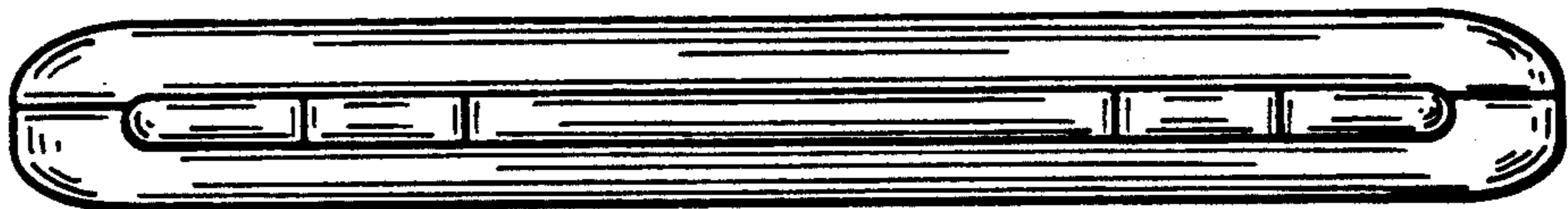
FIG_5



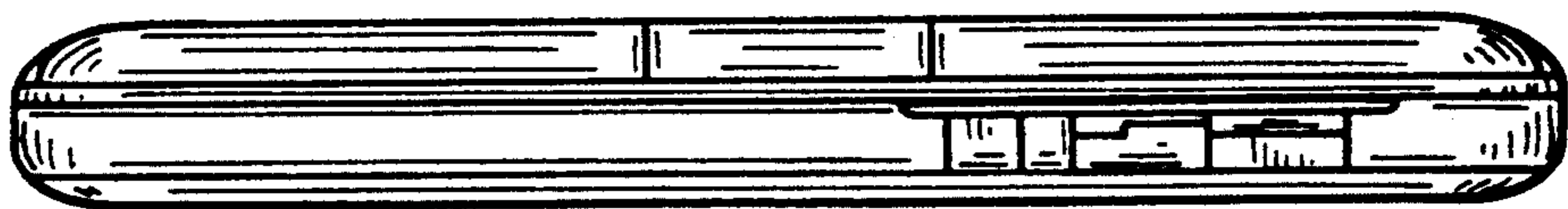
FIG_2



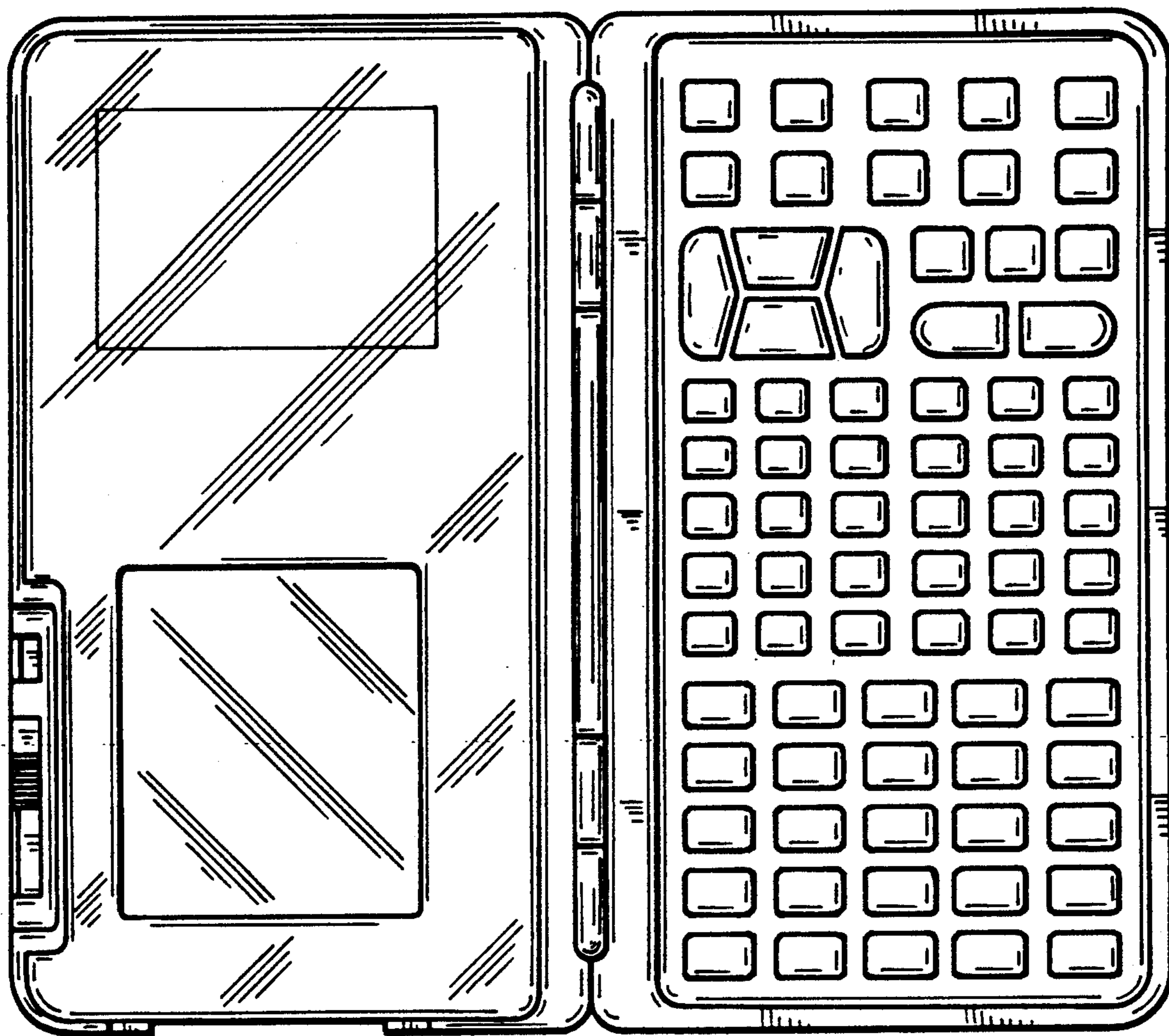
FIG_3



FIG_6



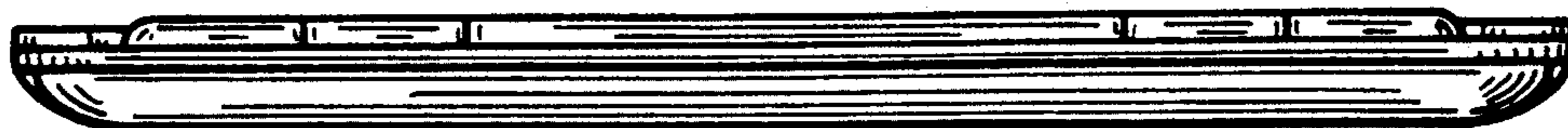
FIG_7



FIG_8



FIG_9



FIG_10